TE Internal #: 3-2180324-2

SFP, SFP+ & zSFP+, Cage Assembly with Integrated Connector,

Data Rate (Max) 32 Gb/s, Internal/External EMI Springs, zSFP+

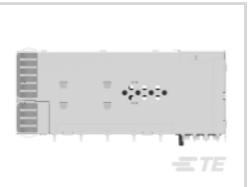
Thermally Enhanced

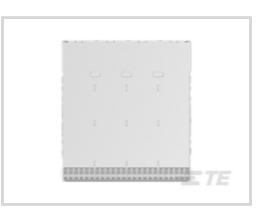
View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+ > zSFP+ Stacked Cage Assembly: EMI Spring











Pluggable I/O Product Type: Cage Assembly with Integrated Connector

Data Rate (Max): 32 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: zSFP+ Thermally Enhanced

Lightpipe Options: With Lightpipe

All zSFP+ Stacked Cage Assembly: EMI Spring (45)

## Features

### **Product Type Features**

| Form Factor zS                        | SFP+ Stacked (SFP28)                   |
|---------------------------------------|--|
| Cage Type Sta                         | tacked                                 |
| Pluggable I/O Product Type Ca         | age Assembly with Integrated Connector |
| Lightpipe Options Wi                  | Vith Lightpipe                         |
| Connector System Ca                   | Cable-to-Board                         |
| Sealable                              | lo                                     |
| Connector & Contact Terminates To Pri | rinted Circuit Board                   |

## **Configuration Features**

| Port Matrix Configuration | 2 x 4          |
|---------------------------|----------------|
| Lightpipe Configuration   | Reversed Outer |
| Lightpipe Style           | Standard       |
| Lightpipe Profile         | Standard       |
| Number of Ports           | 8              |



| Number of Positions                            | 160                                      |
|--|--|
| Electrical Characteristics                     |  |
| Data Rate (Max)                                | 32 Gb/s                                  |
| Contact Features                               |  |
| Tail Plating Material                          | Tin                                      |
| Contact Mating Area Plating Material Thickness | .76 μm[29.92 μin]                        |
| Contact Mating Area Plating Material           | Gold or Gold Flash over Palladium Nickel |
| Contact Current Rating (Max)                   | .5 A                                     |
| Termination Features                           |  |
| Termination Post & Tail Length                 | 1.8 mm[.07 in]                           |
| Termination Method to Printed Circuit Board    | Through Hole - Press-Fit                 |
| Mechanical Attachment                          |  |
| Connector Mounting Type                        | Board Mount                              |
| Housing Features                               |  |
| Cage Material                                  | Nickel Silver Alloy                      |
| Centerline (Pitch)                             | .8 mm[.031 in]                           |
| Dimensions                                     |  |
| PCB Thickness (Recommended)                    | 1.5 mm[.059 in]                          |
| Usage Conditions                               |  |
| Operating Temperature Range                    | -55 – 105 °C[-67 – 221 °F]               |
| Operation/Application                          |  |
| Heat Sink Compatible                           | No                                       |
| For Use With Pluggable I/O Products            | zSFP+ Cable Assembly                     |
| Pluggable I/O Applications                     | zSFP+ Thermally Enhanced                 |
| Circuit Application                            | Signal                                   |
| Industry Standards                             |  |
| UL Flammability Rating                         | UL 94V-0                                 |
| Packaging Features                             |  |
| Packaging Method                               | Tray                                     |
| Other  |  |
| EMI Containment Feature Type                   | Internal/External EMI Springs            |



### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.  |
| Solder Process Capability                     | Not applicable for solder process capability  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**













TE Part # CAT-Q17-N49011

QSFP56-Four SFP56 Cable Assembly:
30 AWG



TE Part # CAT-Q17-N490333 QSFP56-Four SFP56 Cable Assembly: 26 AWG



TE Part # 4-2821222-5 SFP56 DIRECT ATTACH CA, 2M, 30AWG





TE Part # 4-2334985-2 SFP56 DIRECT ATTACH CA, 1M, 32AWG

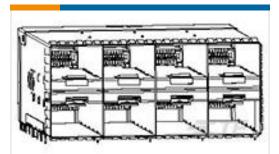


TE Part # 2334985-2 SFP28 DIRECT ATTACH CA, 1M, 32AWG



TE Part # CAT-C11-N490111 SFP28 to SFP28 Cable Assembly: 28 AWG

# Customers Also Bought



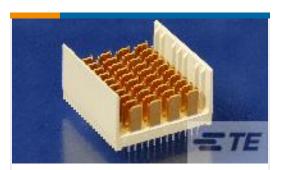
TE Part #1-2180324-9
zSFP+ STACKED 2X4 RECEPTACLE
ASSEMBLY



TE Part #6469081-1 HMZD 3PR, RECEPTACLE ASSEMBLY



TE Part #6469001-1 HM-ZD 4PR RECP 80P



TE Part #6469002-1 HM-ZD 4PR HDR 80P 5.2MM



TE Part #6469028-1 HM-ZD 2PR RECP 40P



TE Part #6469025-1 HM-ZD 2PR HDR 40P 2.5MM



TE Part #2300275-1 zSFP+ 1x4 Cage Assembly, Press-Fit



ZQSFP+ STACKED RECEPTACLE
ASSEMBLY 2X2



TE Part #3-1734857-4
PCI EXP STRADDLE 98P WHT 15u"

TE Part #2381126-1
GUIDE PIN WITH POST KEY

### **Documents**



#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_3-2180324-2\_A.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_3-2180324-2\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_3-2180324-2\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

### **Product Specifications**

**Application Specification** 

English

### **Product Environmental Compliance**

**Product Compliance** 

English

**Product Compliance** 

English